



DMN3035LWN

Product Summary

BV _{DSS}	Rds(on) max	Ι _{D MAX} T _A = +25°C
001/	35mΩ @ V _{GS} = 10V	5.5A
30V	45mΩ @ V _{GS} = 4.5V	4.9A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC Motor Control
- **DC-AC** Inverters

Features

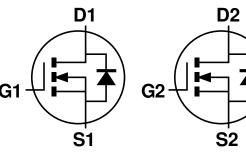
- Low On-Resistance •
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

30V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: V-DFN3020-8 (Type N) •
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.011 grams (Approximate)



Q1 N-Channel MOSFET

Q2 N-Channel MOSFET

Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3035LWN-7	V-DFN3020-8 (Type N)	3,000/Tape & Reel
DMN3035LWN-13	V-DFN3020-8 (Type N)	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

Notes:

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

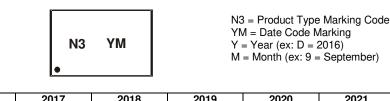
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/quality/lead_free.html.

V

Marking Information

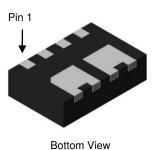
-DFN3020-8	(Type N)
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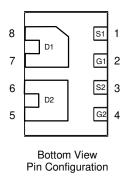


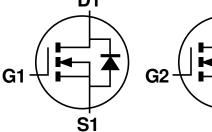
Code	D		Г	G		I	J	r.
Year Code	2016	2017	2018	2019	2020	2021	2022	2023

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

V-DFN3020-8 (Type N)









Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V_{GS} = 10V	T _A = +25°C T _A = +70°C	ID	5.5 4.4	A	
Maximum Continuous Body Diode Forward Curr	ent (Note 6)		ls	1	А
Pulsed Drain Current			I _{DM}	30	А
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	13	А
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	9.0	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Dower Dissipation (Note 5)	T _A = +25°C	D	0.77	\A/	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.49	— W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	162	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	R _{0JA}	116	0/00	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	D	1.78	w	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	PD	1.10	vv	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	71	°C/W	
Thermal Resistance, Junction to Amblent (Note 6)	t<10s	R _θ JA	50	C/W	
Thermal Resistance, Junction to Case (Note 6)	R _{0JC}	10.7	°C/W		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30		—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}			1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1.0		2.0	V	$V_{DS}=V_{GS},I_{D}=250\mu A$	
Static Drain-Source On-Resistance	Proven		26	35	mΩ	$V_{GS} = 10V, I_D = 4.8A$	
	R _{DS(ON)}		34	45	11152	$V_{GS} = 4.5V, I_D = 4.3A$	
Diode Forward Voltage	V _{SD}		0.75	1.1	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	399		pF		
Output Capacitance	Coss		57	—	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	50		pF	1 - 1.00012	
Gate Resistance	Rg		1.36	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg		4.5	—	nC		
Total Gate Charge (V _{GS} = 10V)	Qg		9.9	—	nC		
Gate-Source Charge	Q _{gs}		1.2	—	nC	$V_{DS} = 15V, I_D = 5.8A$	
Gate-Drain Charge	Q _{gd}	_	1.8	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.0	_	ns		
Turn-On Rise Time	t _R	_	3.3	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	10.6	_	ns	$R_L = 2.6\Omega, R_G = 3\Omega$	
Turn-Off Fall Time	t _F	_	2.0	_	ns]	
Reverse Recovery Time	t _{RR}	_	7.9	_	ns	I _F = 4.8A, di/dt = 100A/µs	
Reverse Recovery Charge	Q _{RR}		2.4		nC	I _F = 4.8A, di/dt = 100A/µs	

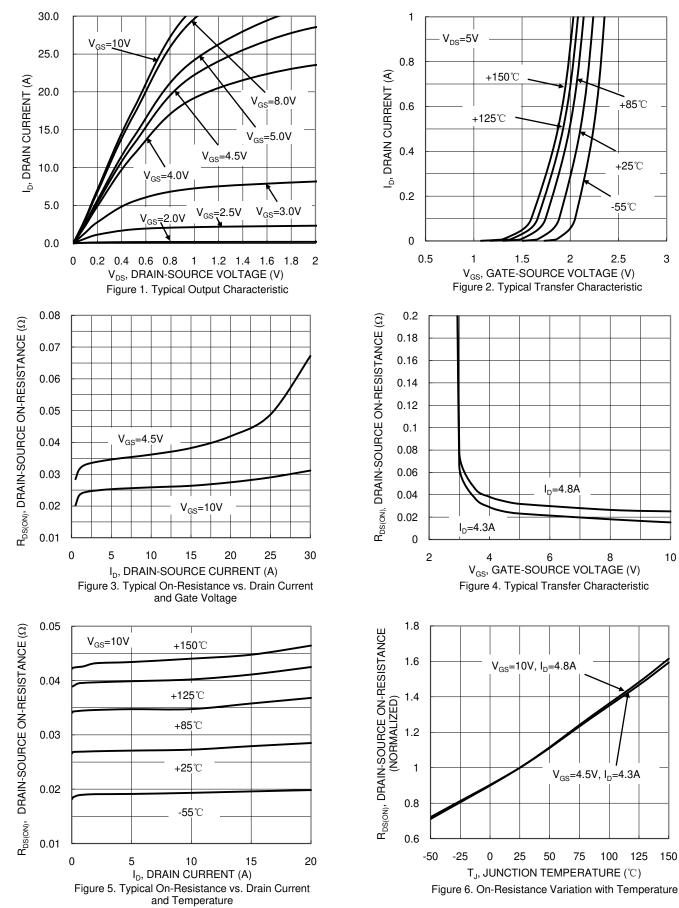
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

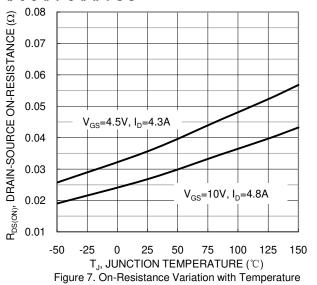


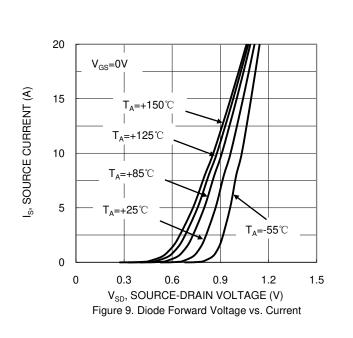
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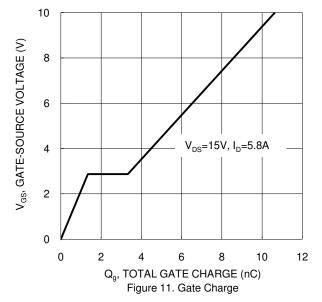


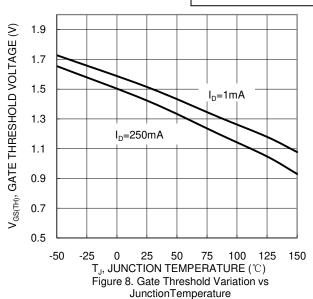


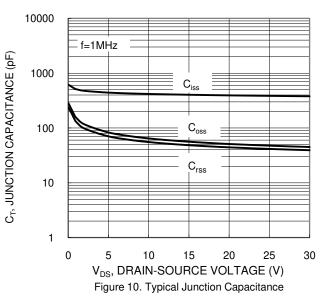
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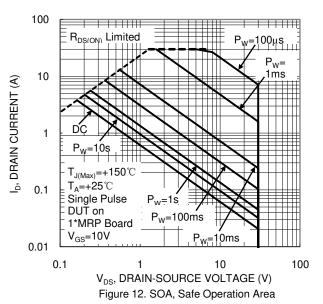






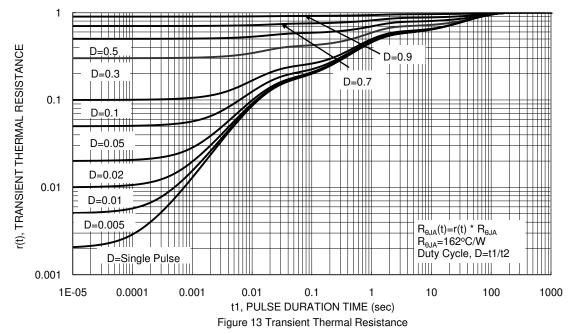






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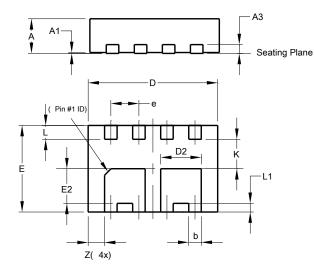




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

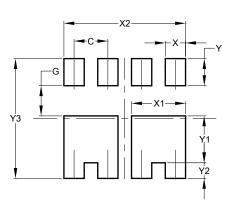
V-DFN3020-8 (Type N)



	V-DF	N3020-	·8
	(Ту	pe N)	
Dim	Min	Тур	
Α	0.77	0.83	0.80
A1	0	0.05	0.02
A3	-	-	0.203
b	0.24	0.34	0.29
D	2.95	3.05	3.00
D2	0.84	1.04	0.94
е	-	-	0.65
Е	1.95	2.05	2.00
E2	0.70	0.90	0.80
L	0.27	0.37	0.32
L1	0.15	0.25	0.20
К	-	-	0.68
Z	-	-	0.38
	Dimen	sions i	in mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



V-DFN3020-8 (Type N)

Dimensions	Value (in mm)
С	0.650
G	0.580
Х	0.390
X1	1.040
X2	2.340
Y	0.520
Y1	0.900
Y2	0.300
Y3	2.300

DMN3035LWN Document number: DS37528 Rev. 3 - 2



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